

PATENT
81756.0003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

SEKI, et al.

Serial No: 09/297,483

Filed: July 19, 1999

For: METHOD OF PRODUCING ORGANIC
EL ELEMENT AND ORGANIC EL
ELEMENT

Art Unit: 1762

Examiner: CLEVELAND, M.

I hereby certify that this paper and every
paper referred to herein is being
transmitted via facsimile to Mr. Michael
Cleveland at Commissioner 3700,
USPTO at (703) 306-3816 on:

November 22, 2000

Date of Facsimile Transmission

William H. Wright, Reg. No. 36312

Name

November 22, 2000

Signature

Date

SUPPLEMENTAL AMENDMENTCommissioner for Patents
Washington, D.C. 20231

Dear Sir:

Please enter and consider the following amendments:

IN THE CLAIMS:

Please cancel all pending claims and add new claims 37-61 as follows:

--37. A manufacturing process for an organic EL element having a stacked structure including a hole injecting and transporting layer and a light-emitting layer formed within a partitioning member which is divided into individual pixel areas, the method comprising:

forming the partitioning member on a substrate, the partitioning member having openings corresponding to pixel areas;

filling the openings with a composition for the hole injecting and transporting layer using an ink-jet recording head, the composition comprising (1) a conductive material containing at least polyethylenedioxythiophene and polystyrene sulfonic acid, and (2) a solvent; and

drying the composition filled in the openings to form the hole injecting and transporting layer.

38. The manufacturing process of claim 37, wherein the conductive material is contained in an amount of 0.01 wt% to 10 wt% of the composition, and wherein a contact angle